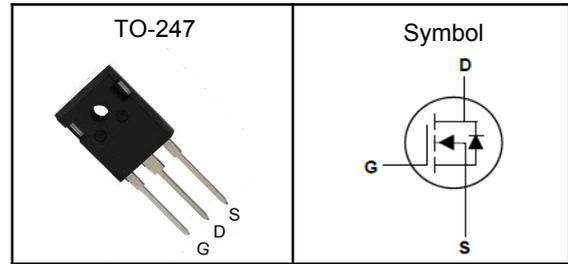


**N-Channel Enhancement Mode MOSFET**
**Features**

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant
- 100% UIS and Rg Tested

**Applications**

- Power Management in Desktop Computer
- DC/DC Converters

**Pin Description**


$V_{DSS}$	300	V
$R_{DS(ON)-Typ}$	36	m $\Omega$
$I_D$	70	A

**Absolute Maximum Ratings**( $T_J=25^\circ\text{C}$ , Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
$V_{DSS}$	Drain-Source Voltage	300	V
$V_{GSS}$	Gate-Source Voltage	$\pm 30$	V
$T_J$	Maximum Junction Temperature	-55 to 150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
$E_{AS}$	Single Pulse Avalanche Energy <sup>③</sup>	3450	mJ
$I_{DM}^{①}$	Pulse Drain Current Tested	280	A
$I_D$	Continuous Drain Current	$T_c=25^\circ\text{C}$ 70	A
$P_D$	Maximum Power Dissipation	$T_c=25^\circ\text{C}$ 250	W

**Thermal Characteristics**

Symbol	Parameter	Rating	Unit
$R_{\theta JA}$	Thermal Resistance Junction-Ambient <sup>①</sup>	40	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance Junction-Case <sup>①</sup>	0.5	$^\circ\text{C}/\text{W}$

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150 $^\circ\text{C}$ .

Note ③ : Surface Mounted on 1in<sup>2</sup> FR-4 board with 1oz.



**N-Channel Enhancement Mode MOSFET**

**Electrical Characteristics** ( $T_J=25^{\circ}\text{C}$ , Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
<b>Static Electrical Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	300	---	---	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=300V, V_{GS}=0V$	---	---	1	$\mu A$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0	---	4.0	V
$I_{GSS}$	Gate Leakage Current	$V_{GS}=\pm 30V, V_{DS}=0V$	---	---	$\pm 10$	$\mu A$
$R_{DS(ON)}$	Drain-Source On-state Resistance	$V_{GS}=10V, I_D=35A$	---	36	42	$m\Omega$
<b>Dynamic Characteristics</b> <sup>⑤</sup>						
$C_{iss}$	Input Capacitance	$V_{GS}=0V,$ $V_{DS}=25V,$ $Freq.=1MHz$	---	8280	---	pF
$C_{oss}$	Output Capacitance		---	900	---	
$C_{rss}$	Reverse Transfer Capacitance		---	100	---	
$T_{d(on)}$	Turn-on Delay Time	$V_{DD}=150V,$ $V_{GS}=10V,$ $R_G=25\Omega, I_D=70A$	---	82	---	nS
$T_r$	Turn-on Rise Time		---	300	---	
$T_{d(off)}$	Turn-off Delay Time		---	190	---	
$T_f$	Turn-off Fall Time		---	135	---	
$Q_g$	Total Gate Charge	$V_{DD}=240V,$ $V_{GS}=10V, I_D=70A$	---	136	---	nC
$Q_{gs}$	Gate-Source Charge		---	42	---	
$Q_{gd}$	Gate-Drain Charge		---	46	---	
<b>Source-Drain Characteristics</b> ( $T_J=25^{\circ}\text{C}$ )						
$V_{SD}$	Diode Forward Voltage <sub>2</sub>	$V_{GS}=0V, I_S=70A, T_J=25^{\circ}\text{C}$	---	0.8	1.4	V
$t_{rr}$	Reverse Recovery Time	$I_F=70A,$ $di/dt=100A/\mu s, T_J=25^{\circ}\text{C}$	---	360	---	nS
$Q_{rr}$	Reverse Recovery Charge		---	3	---	$\mu C$

Note ④ : Pulse test (pulse width $\leq 300\mu s$ , duty cycle $\leq 2\%$ ).

Note ⑤ : Guaranteed by design, not subject to production testing.

# N-Channel Enhancement Mode MOSFET

## Typical Characteristics

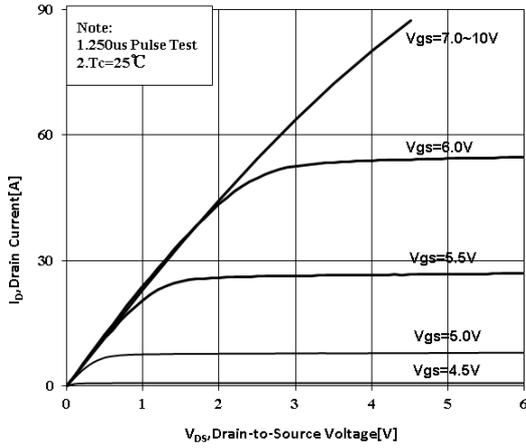


Figure 1 Typical Output Characteristics

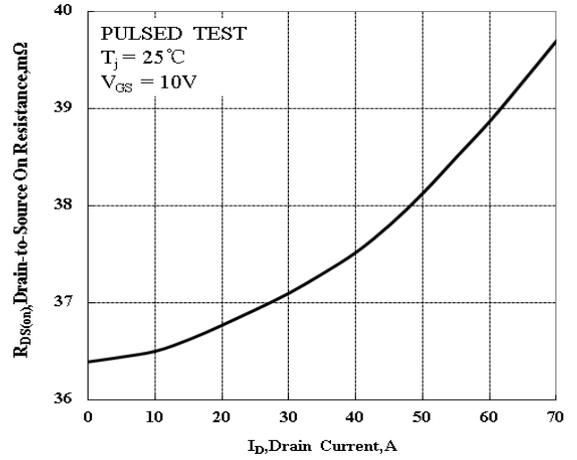


Figure 2 Typical Drain to Source ON Resistance vs Drain Current

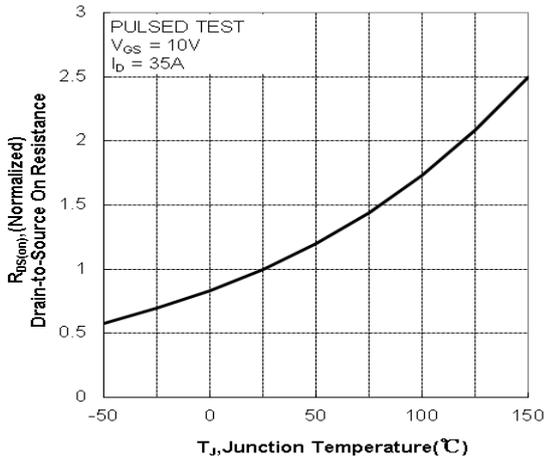


Figure 3 Typical Drain to Source on Resistance vs Junction Temperature

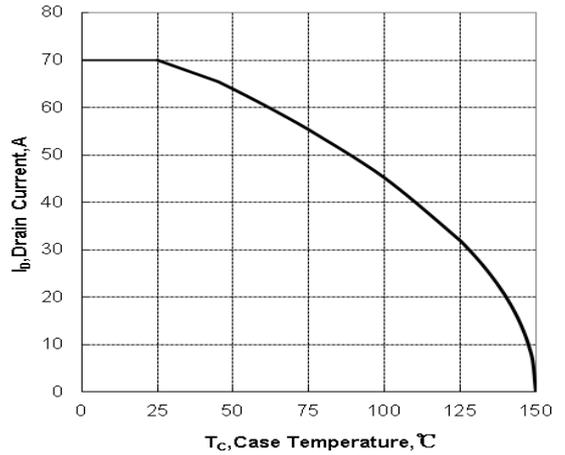


Figure 4 Maximum Continuous Drain Current vs Case Temperature

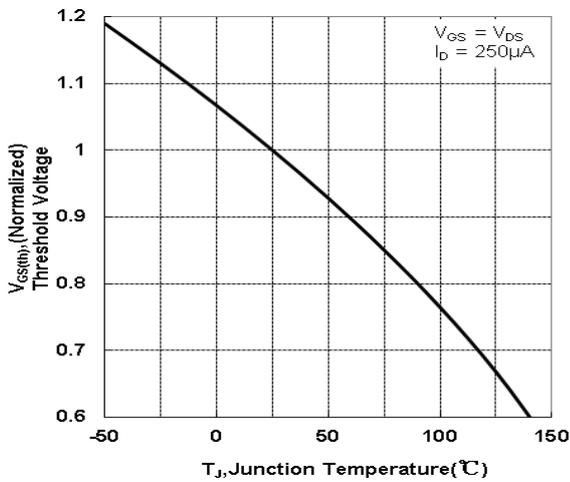


Figure 5 Typical Threshold Voltage vs Junction Temperature

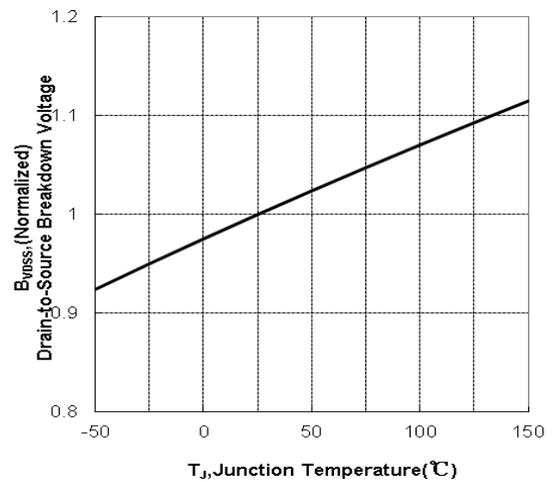


Figure 6 Typical Breakdown Voltage vs Junction Temperature

# N-Channel Enhancement Mode MOSFET

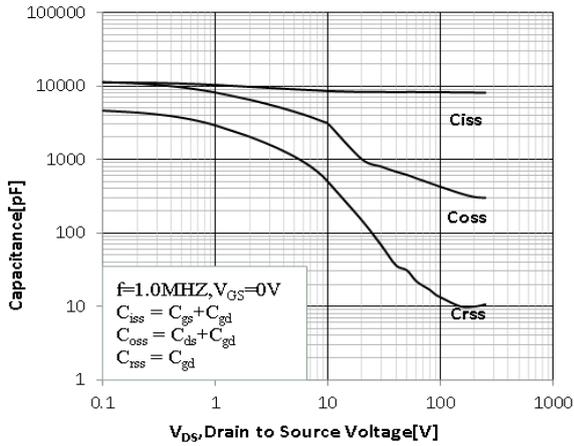


Figure 7 Typical Capacitance vs Drain to Source Voltage

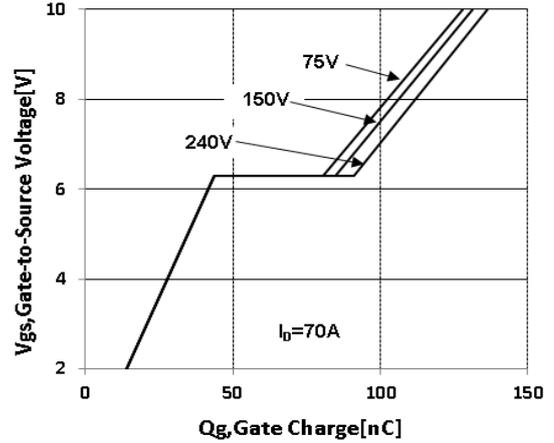


Figure 8 Typical Gate Charge vs Gate to Source Voltage

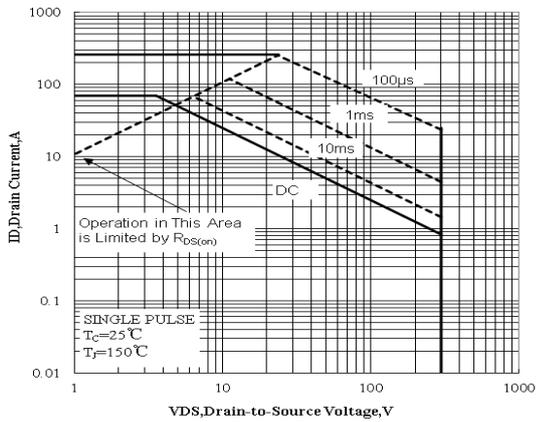


Figure 9 Maximum Forward Bias Safe Operating Area

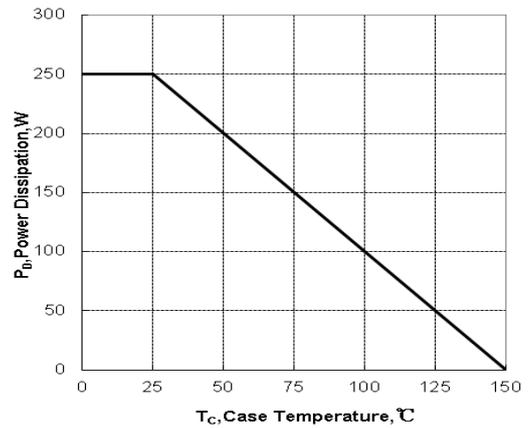


Figure 10 Maximum Power dissipation vs Case Temperature

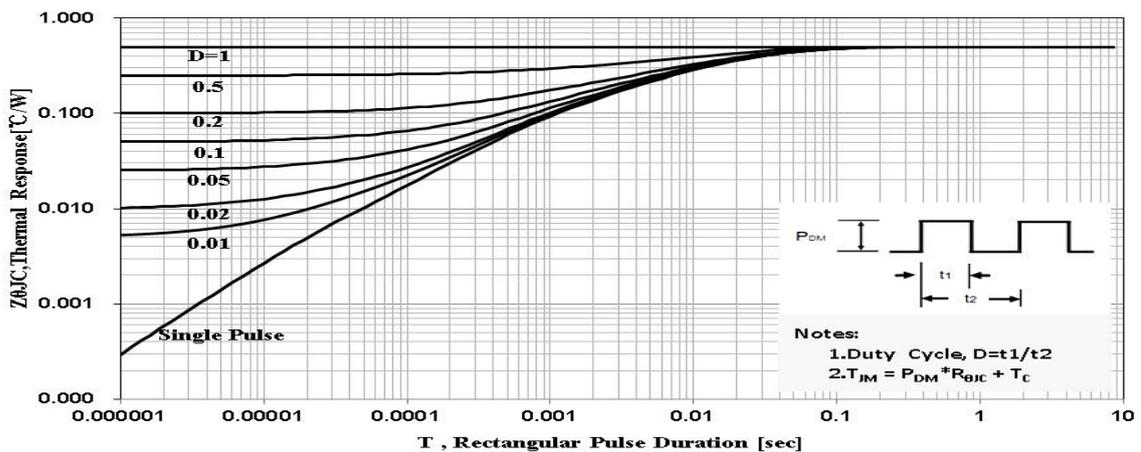
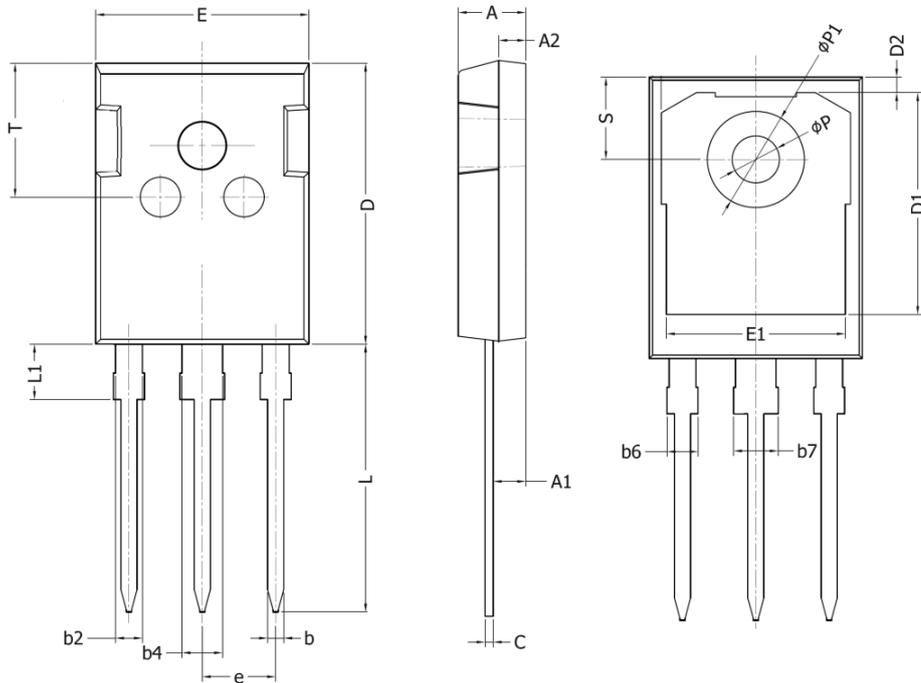


Figure 11 Maximum Effective Thermal Impedance , Junction to Case

**N-Channel Enhancement Mode MOSFET**
**TO-247 Package Outline Dimensions**


Symbol	Dimensions In Millimeters	
	Min.	Max.
A	4.90	5.20
A1	2.31	2.51
A2	1.9	2.1
b	1.16	1.26
b2	1.96	2.06
b4	2.96	3.06
b6	-	2.25
b7	-	3.25
C	0.59	0.66
D	20.90	21.20
D1	16.25	16.85
D2	1.05	1.35
E	15.75	16.10
E1	13.00	13.60
e	5.436 BSC	
L	19.80	20.20
L1	-	4.30
P	3.40	3.60
P1	7.00	7.40
S	6.05	6.25
T	9.80	10.20